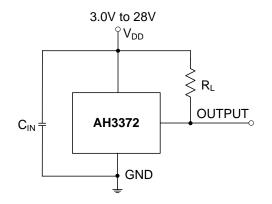


Typical Applications Circuit



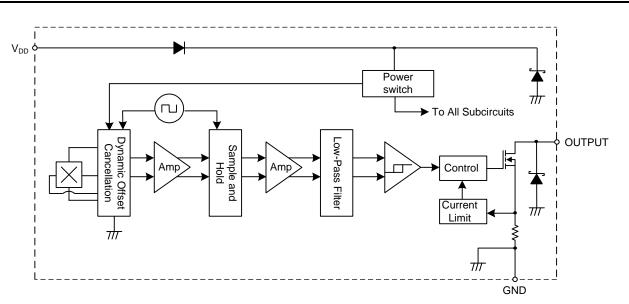
Note: 4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 10nF ~ 100nF. R_L is the pull-up resistor.

Pin Descriptions

Package: SC59, SOT23 and SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)

Pin Number	Pin Name	Function
1	V _{DD}	Power Supply Input
2	GND	Ground
3	OUTPUT	Output Pin

Functional Block Diagram





Absolute Maximum Ratings (Notes 5 & 6) (@T_A = +25°C, unless otherwise specified.)

Symbol	Characteristic		Value	Unit	
V _{DD}	Supply Voltage (Note 6)		32	V	
V _{DDR}	Reverse Supply Voltage (Note 6)		-32	V	
V _{OUT_MAX}	Output Off Voltage (Note 6)		32	V	
Ι _{Ουτ}	Continuous Output Current	60	mA		
I _{OUT_R}	Reverse Output Current	-50	mA		
В	Magnetic Flux Density		Unlimited		
PD	Package Power Dissipation	SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)	550	mW	
2		SC59 and SOT23	230		
Ts	Storage Temperature Range	-65 to +165	°C		
TJ	Maximum Junction Temperature	+150	°C		
ESD HBM	Electros Static Discharge Withstand - Human Body Model (HBI	VI)	6	kV	

Notes: 5. Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.

6. The absolute maximum V_{DD} of 32V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

Recommended Operating Conditions (@T_A = -40°C to +125°C, unless otherwise specified.)

Symbol	Parameter	Condition	Rating	Unit
V _{DD}	Supply Voltage	Operating	3.0 to 28	V
T _A	Operating Temperature Range	Operating	-40 to +125	°C

Electrical Characteristics (Note 7 & 8) (@T_A = -40°C to +125°C, V_{DD} = 3V to 28V, unless otherwise specified.)

Symbol	Parameter	Condition	Min	Тур	Max	Unit
V _{OUT_ON}	Output ON Voltage	I _{OUT} = 20mA, B > B _{OP}	-	0.2	0.4	V
I _{LKG}	Output Leakage Current (When output is off)	$V_{OUT} = 28V, B < B_{RP}, Output off$	-	<0.1	10	μΑ
	Supply Current	Output open, $T_A = +25^{\circ}C$	-	3	3.5	mA
I _{DD}	Supply Current	Output open, T _A = -40°C to +125°C	-	-	4	mA
	Roverse Pottery Current	V _{DD} = -18V, T _A = -40°C to +125°C	-	-0.01	1	mA
IDD_R	Reverse Battery Current	$V_{DD} = -28V, T_A = -40^{\circ}C \text{ to } +125^{\circ}C$	-	-0.01	1.5	mA
t _{P_ON}	Device Power-On Time (Start-up time)	$V_{DD} \ge 3V, B \ge B_{OP}$ (Note 7)	-	10	-	μs
f _C	Chopping Frequency	-	-	800	-	kHz
t _D	Response Time Delay (Time from magnetic threshold reached to the start of the output rise or fall)	(Note 9)	-	3.75	-	μs
t _R	Output Rising Time (External pull-up resistor R⊾and load capacitance dependent)	$R_L = 1k\Omega, C_L = 20pF$	-	0.2	1	μs
tF	Output Falling Time (Internal switch resistance and load capacitance dependent)	$R_L = 1k\Omega, C_L = 20pF$	-	0.1	1	μs
I _{OCL}	Output Current Limit	B > B _{OP} , (Note 10)	30	-	55	mA
V ₇	Zener Clamp Voltage	$I_{DD} = 5 mA$	28	-	-	V

Notes: 7. When power is initially turned on, Vbb must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10µs typical from the operating voltage reaching 3V.

8. Typical values are defined at T_A = +25°C, V_{DD} = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization.

9. Guaranteed by design, process control and characterization, Not tested in production.

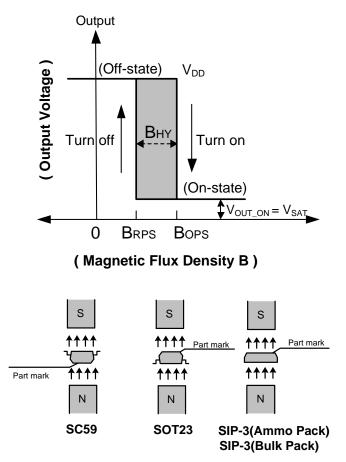
10. The device will limit the output current I_{OUT} to current limit of I_{OCL}



Magnetic Characteristics (Notes 11 &12) (T_A = -40°C to +125°C, V_{DD} = 3.0V to 28V, unless otherwise specified.)

				(1mT=10 (Gauss)
Symbol	Parameter	Condition	Min	Тур	Max	Unit
B _{OPS} (South pole to the part marking side for SOT23 and SIP-3 (Ammo Pack),		V _{DD} = 12V, T _A = +25°C	-	30	-	
SIP-3 (Bulk Pack) packages; South pole to the non-part marking side for SC59 package. See diagram below)	Operation Point	$T_A = -40^{\circ}C$ to $+125^{\circ}C$	15	30	45	
B _{RPS} (South pole to the part marking side for SOT23 and SIP-3 (Ammo Pack),		V _{DD} = 12V, T _A = +25°C	-	20	-	
SIP-3 (Bulk Pack) packages; South pole to the non-part marking side for SC59 package. See diagram below)	Release Point	$T_A = -40^{\circ}C$ to $+125^{\circ}C$	5	20	35	Gauss
Dury (ID and ID and)	Hysteresis (Note 13)	V _{DD} = 12V, T _A = +25°C	-	10	-	
Bhy (Bopx - Brpx)		$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$	5	10	17	

 When power is initially turned on, V_{DD} must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10us typical from the operating voltage reaching 3V.
Typical values are defined at T_A = +25°C, V_{DD} = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization.
Maximum and minimum hysteresis is guaranteed by design, process control and characterization. Notes:





B_{OPS}

B_{RPS}

B_{HYS}

 $\mathsf{B}_{\mathsf{OPS}}$

B_{RPS}

 $\mathsf{B}_{\mathsf{HYS}}$

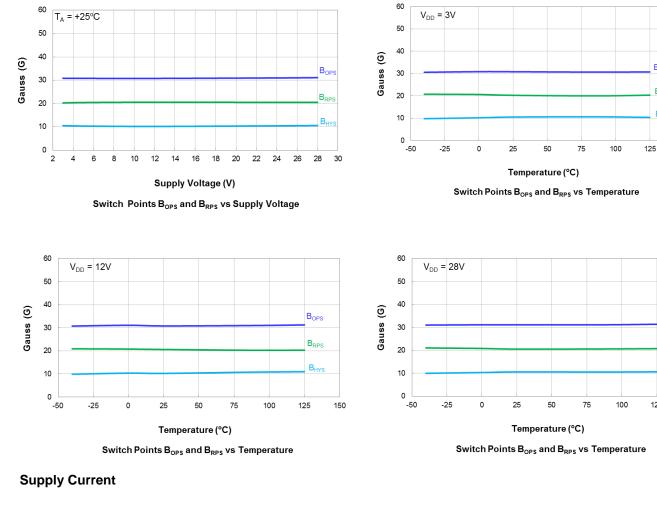
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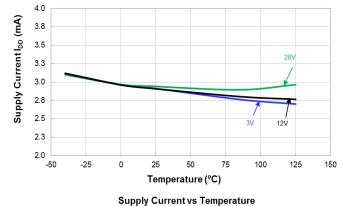
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150

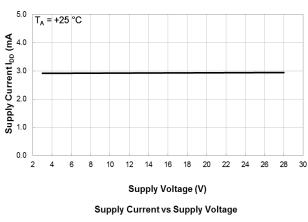
Typical Operating Characteristics

Output Switch Operate and Release Points (Magnetic Thresholds) – B_{OPS} and B_{RPS}





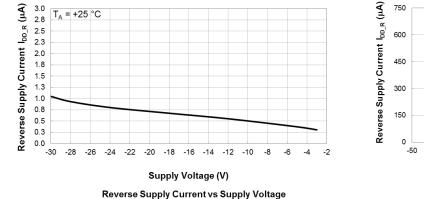
NEW PRODUCT



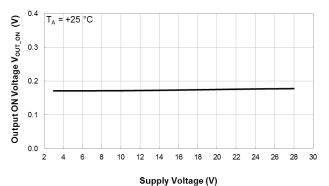


Typical Operating Characteristics (Cont.)

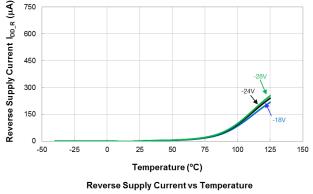
Supply Reverse Current

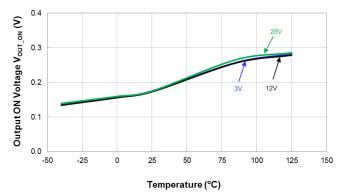


Output Switch On Voltage

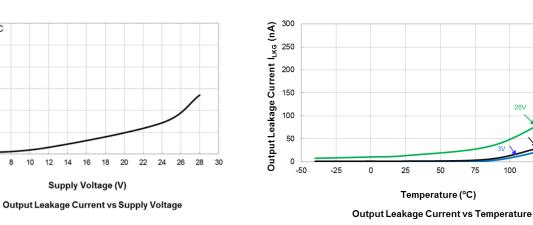


Output ON Voltage vs Supply Voltage





Output ON Voltage vs Temperature



Output Switch Leakage Current

12 14 16 18

Output Leakage Current I_{LKG} (nA)

30

25

20

15

10

5

0

2

4

6 8 10

T_A = +25 °C

28\

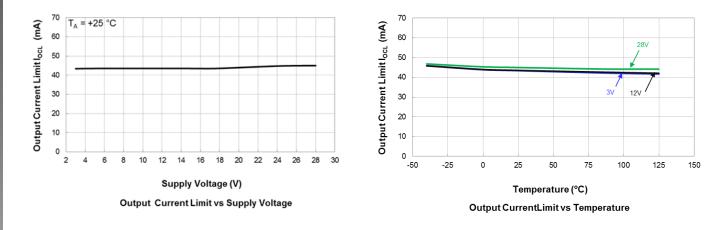
125

150



Typical Operating Characteristics (Cont.)

Output Current Limit

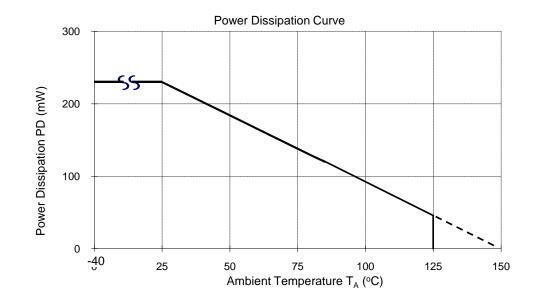




Thermal Performance Characteristics

(1) Package Type: SC59 and SOT23

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	230	184	166	147	129	120	110	92	83	74	55	46	37	18	0

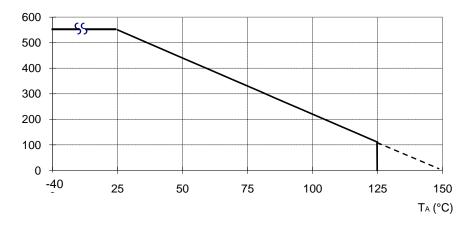


(2) Package Type: SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	550	440	396	362	308	286	264	220	198	176	132	110	88	44	0

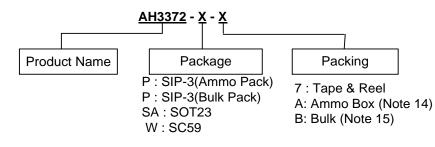
P_D (mW)

Power Dissipation Curve





Ordering Information

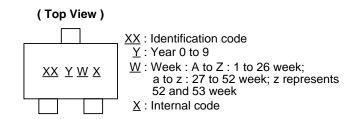


	Package		В	ulk	7" Tape an	d Reel	Amm	no Box
Part Number	Code	Packaging	Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH3372-P-A	Р	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3372-P-B	Р	SIP-3 (Bulk Pack)	1000	-B	NA	NA	NA	NA
AH3372-SA-7	SA	SOT23	NA	NA	3000/Tape & Reel	-7	NA	NA
AH3372-W-7	W	SC59	NA	NA	3000/Tape & Reel	-7	NA	NA

Notes: 14. Ammo Box is for SIP-3 (Ammo Pack) Spread Lead. 15. Bulk is for SIP-3 (Bulk Pack) Straight Lead.

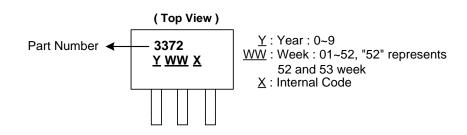
Marking Information

(1) Package Type: SC59 and SOT23



Part Number	Package	Identification Code
AH3372	SC59	DS
AH3372	SOT23	MS

(2) Package Type: SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)



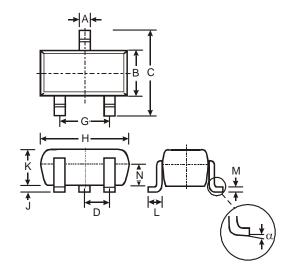
Part Number	Package	Identification Code
AH3372	SIP-3(Ammo Pack)	3372
AH3372	SIP-3(Bulk Pack)	3372



Package Outline Dimensions (All dimensions in mm.)

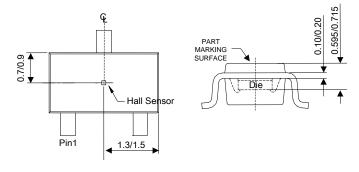
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SC59



	SC	59	
Dim	Min	Max	Тур
Α	0.35	0.50	0.38
в	1.50	1.70	1.60
C	2.70	3.00	2.80
D	-	-	0.95
G	-	-	1.90
Н	2.90	3.10	3.00
J	0.013	0.10	0.05
ĸ	1.00	1.30	1.10
L	0.35	0.55	0.40
Μ	0.10	0.20	0.15
Ν	0.70	0.80	0.75
α	0°	8°	-
All	Dimens	ions in	mm

Min/Max



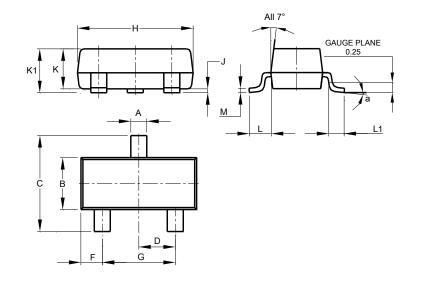
Sensor Location



Package Outline Dimensions (Cont.) (All dimensions in mm.)

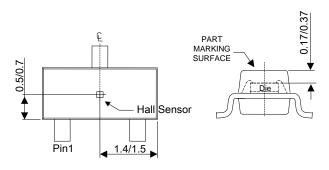
Please see http://www.diodes.com/package-outlines.html for the latest version.

(2) Package Type: SOT23



	SO	Г23	
Dim	Min	Max	Тур
Α	0.37	0.51	0.40
В	1.20	1.40	1.30
С	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
Н	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
М	0.085	0.150	0.110
а	0°	8°	
All D	Dimensi	ions in I	mm

Min/Max

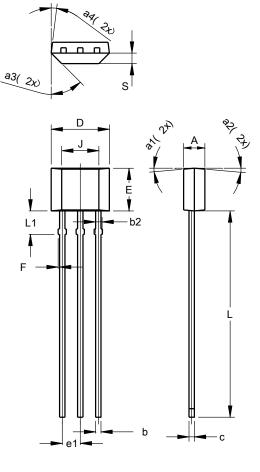


Sensor Location

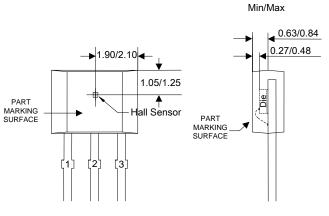


Package Outline Dimensions (Cont.) (All dimensions in mm.)

Please see http://www.diodes.com/package-outlines.html for the latest version. (3) Package Type: SIP-3 (Bulk Pack)



SIP-3 (Bulk Pack)				
Dim	Min	Max	Тур	
Α	1.40	1.60	1.50	
b	0.33	0.43	0.38	
b2	0.40	0.508	0.46	
С	0.35	0.41	0.38	
D	3.90	4.30	4.10	
Е	2.80	3.20	3.00	
e1	1.24	1.30	1.27	
F	0.00	0.20		
J	2.62 REF			
L	14.00	15.00	14.50	
L1	1.55	1.75	1.65	
S	0.63	0.84	0.74	
a1			5°	
a2			5°	
a3			45°	
a4			3°	
All Dimensions in mm				



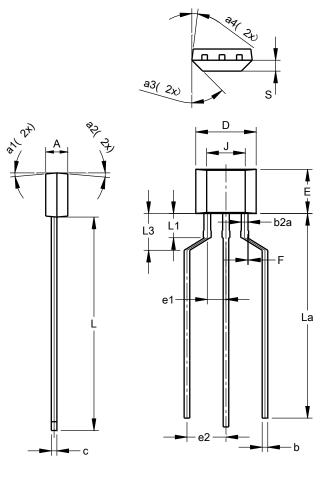
Sensor Location



Package Outline Dimensions (Cont.) (All dimensions in mm.)

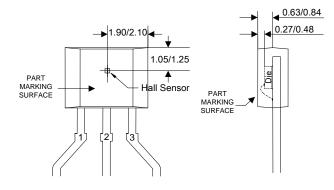
Please see http://www.diodes.com/package-outlines.html for the latest version.

(4) Package Type: SIP-3 (Ammo Pack)



	015					
	SIP-3 (Ammo Pack)					
Dim	Min	Max	Тур			
Α	1.40	1.60	1.50			
b	0.33	0.43	0.38			
b2a	0.40	0.52	0.46			
С	0.35	0.41	0.38			
D	3.90	4.30	4.10			
E	2.80	3.20	3.00			
e1	1.24	1.30	1.27			
e2	2.40	2.90	2.65			
F	0.00	0.20				
J	2.62 REF					
L	14.00	15.00	14.50			
La	12.90	14.90	13.90			
L1	1.55	1.75	1.65			
L3	2.00	3.00	2.50			
s	0.63	0.84	0.74			
a1			5°			
a2			5°			
a3			45°			
a4			3°			
All Dimensions in mm						

Min/Max



Sensor Location

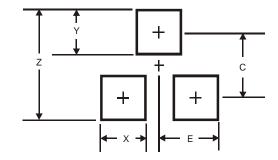
AH3372 Document number: DS38874 Rev. 2 - 2 Downloaded from Arrow.com.



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

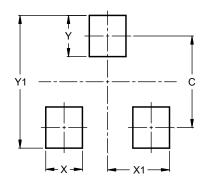
(1) Package Type: SC59



Dimensions	Value (in mm)
Z	3.4
Х	0.8
Y	1.0
С	2.4
E	1.35

(2) Package Type: SOT23

NEW PRODUCT



Dimensions	Value (in mm)	
С	2.0	
Х	0.8	
X1	1.35	
Y	0.9	
Y1	2.9	



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